

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Youn Eung Lee</td> <td>06/19/2013</td> </tr> <tr> <td>Jin Kyu Lee</td> <td>06/19/2013</td> </tr> <tr> <td>Young Taek Oh</td> <td>06/19/2013</td> </tr> </tbody> </table>		Name	Execution Date	Youn Eung Lee	06/19/2013	Jin Kyu Lee	06/19/2013	Young Taek Oh	06/19/2013		
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RECEIVING PARTY DATA											
<table border="1"> <tr> <td>Name:</td> <td>Samsung Fine Chemicals Co., Ltd.</td> </tr> <tr> <td>Street Address:</td> <td>190 Yeocheon-dong, Nam-gu</td> </tr> <tr> <td>City:</td> <td>Ulsan</td> </tr> <tr> <td>State/Country:</td> <td>KOREA, REPUBLIC OF</td> </tr> <tr> <td>Postal Code:</td> <td>680-090</td> </tr> </table>		Name:	Samsung Fine Chemicals Co., Ltd.	Street Address:	190 Yeocheon-dong, Nam-gu	City:	Ulsan	State/Country:	KOREA, REPUBLIC OF	Postal Code:	680-090
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CORRESPONDENCE DATA											
Fax Number:	8602860115										
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NAME OF SUBMITTER:	James J. Merrick										
Signature:	/James J. Merrick/										

Date:

06/21/2013

Total Attachments: 2

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ASSIGNMENT

WHEREAS I(We), LEE, Youn Eung of 308-1206 Paragon Apt., Taepyeong 2-dong, Jung-gu, Daejeon 301-152 Republic of Korea; LEE, Jin Kyu of 103-1007 Gudeok Daelim Apt., Hakjang-dong, Sasang-gu, Busan 617-774 Republic of Korea and OH, Young Taek of Rm. 204 Seogyo City Villa, 465-5 Seogyo-dong, Mapo-gu, Seoul 121-842 Republic of Korea; (hereinafter referred to as "ASSIGNORS"); have invented certain new and useful improvements in:

FIBER WEB, PREPARATION METHOD THEREOF, AND FILTER INCLUDING FIBER WEB

which claims the benefit of the filing date Korean Application No. **10-2011-0001081**, filed on **5 January 2011** in the Korean Intellectual Property Office, and for which We are about to file an application for Letters Patent of the United States;

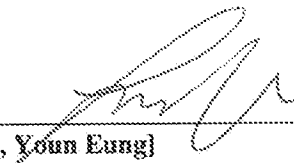
AND WHEREAS SAMSUNG FINE CHEMICALS CO., LTD. (hereinafter referred to as "ASSIGNEE"), a corporation organized and existing under the laws of the Country of Rep. of Korea, having a place of business at 190 Yeocheon-dong, Nam-gu, Ulsan 680-090 Rep. of Korea is desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefore;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that, for good and valuable consideration, the receipt of which is hereby acknowledged, We, the said ASSIGNORS have assigned and transferred, and hereby assign and transfer unto the said ASSIGNEE, the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application; and We do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof, to the said ASSIGNEE, an assignee of the entire right, title and interest in and to the same, for the sole use and behoof of ASSIGNEE, its successors and assigns; and We do hereby agree that the said ASSIGNEE, may apply for foreign Letters Patent on said invention and that We will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said ASSIGNEE, its successors or assigns, and that We will, at the cost and expense of the said ASSIGNEE fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

The undersigned declare that all statements made herein of their own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001

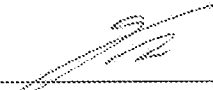
of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: 2013. 6. 19



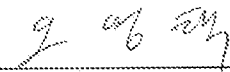
[LEE, Youn Eung] L.S.

Date: 2013. 6. 19



[LEE, Jin Kyo] L.S.

Date: 2013. 6. 19



[OH, Young Taek] L.S.